

SOD-123FL Plastic-Encapsulate Diodes

DSS22 THRU DSS220 Schottky Rectifier Diodes

Features

- $I_{F(AV)}$ 2A
- V_{RRM} 20V-200V
- High surge current capability
- Polarity: Color band denotes cathode

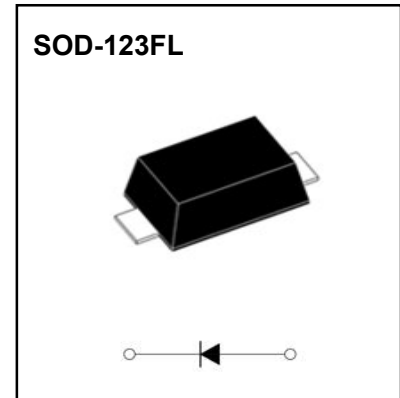
Applications

- Rectifier

Marking

- S2X

X : From 2 To 20



Limiting Values(Absolute Maximum Rating)

Item	Symbol	Unit	Test Conditions	DSS2								
				2	3	4	5	6	8	10	15	20
Repetitive Peak Reverse Voltage	V _{RRM}	V		20	30	40	50	60	80	100	150	200
Maximum RMS Voltage	V _{RMS}	V		14	21	28	35	42	56	70	105	140
Average Forward Current	I _{F(AV)}	A	60Hz Half-sine wave , Resistance load	2.0								
Surge(Non-repetitive)Forward Current	I _{FSM}	A	60Hz Half-sine wave , 1 cycle, Ta=25℃	50								
Junction Temperature	T _J	℃		-55~+125			-55~+150					
Storage Temperature	T _{STG}	℃		-55 ~ +150								

Electrical Characteristics ($T = 25^{\circ}\text{C}$ Unless otherwise specified)

Item	Symbol	Unit	Test Condition		DSS2								
					2	3	4	5	6	8	10	15	20
Peak Forward Voltage	V _F	V	I _F =2.0A		0.55			0.70		0.85		0.95	
Peak Reverse Current	I _{RRM1}	mA	V _{RM} =V _{RRM}	T _a =25℃	0.5				0.1				
			T _a =100℃	10				5.0					
Thermal Resistance(Typical)	R _{θJ-A}	℃/ W	Between junction and ambient		54								
	R _{θJ-L}		Between junction and lead		10								
Juction Capacitance (Typical)	Cj	pF	Measured at 1MHZ and Applied Reverse Voltage of 4.0 V.D.C		114			92		53		40	

Notes:

Thermal resistance from junction to ambient and from junction to lead mounted on FR4 PCB double sided copper mini pad

Typical Characteristics

FIG.1: FORWARD CURRENT DERATING CURVE

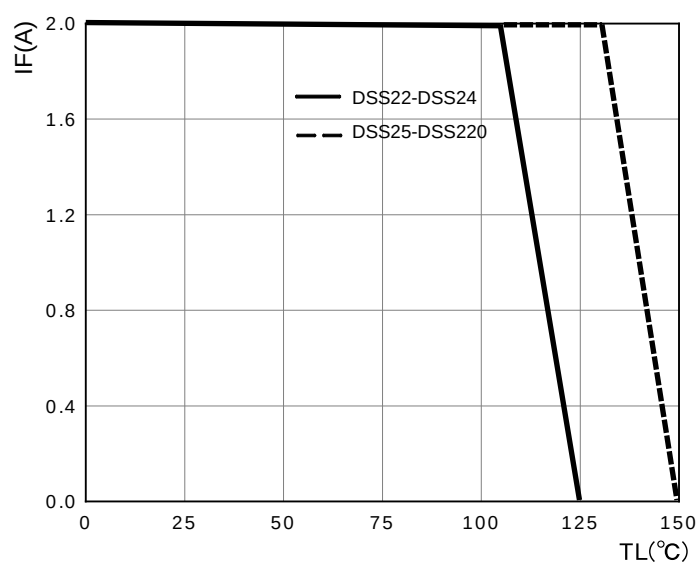
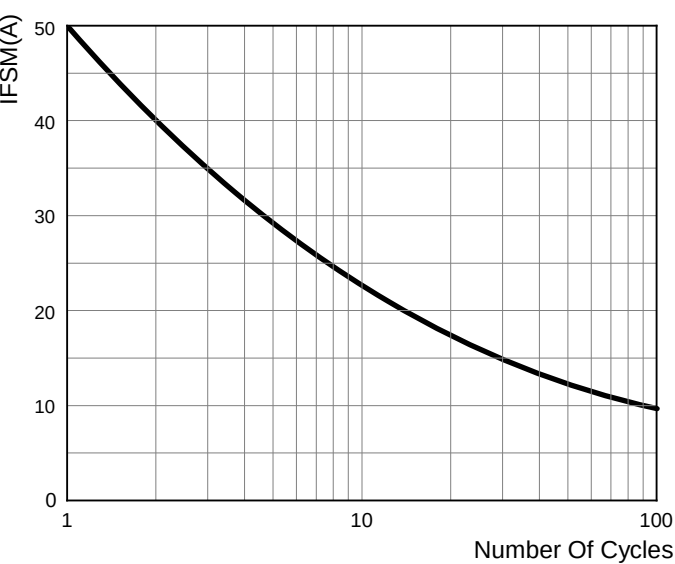
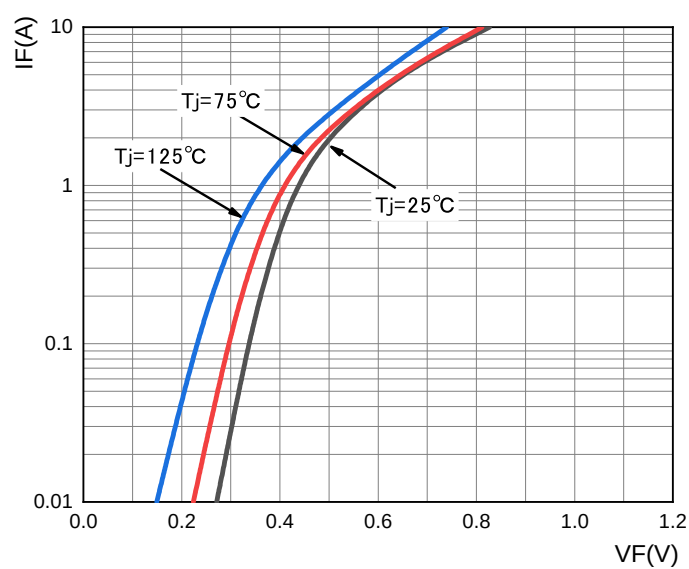


FIG 2: MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT



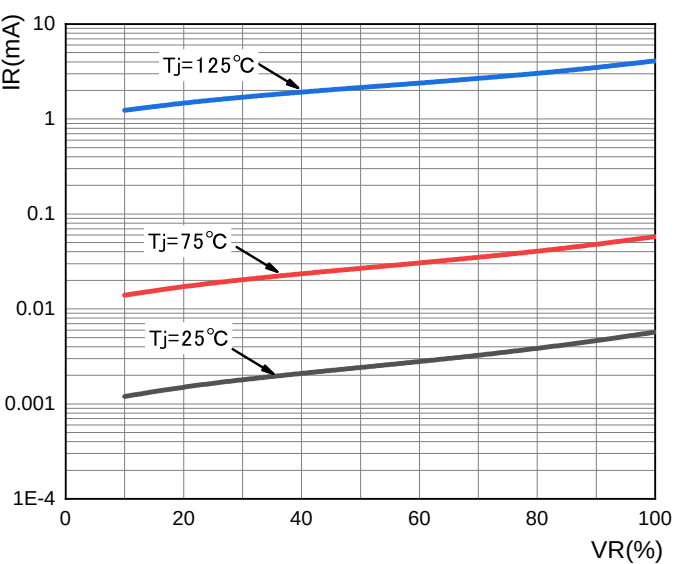
DSS22-DSS24

FIG.3: TYPICAL FORWARD CHARACTERISTICS



DSS22-DSS24

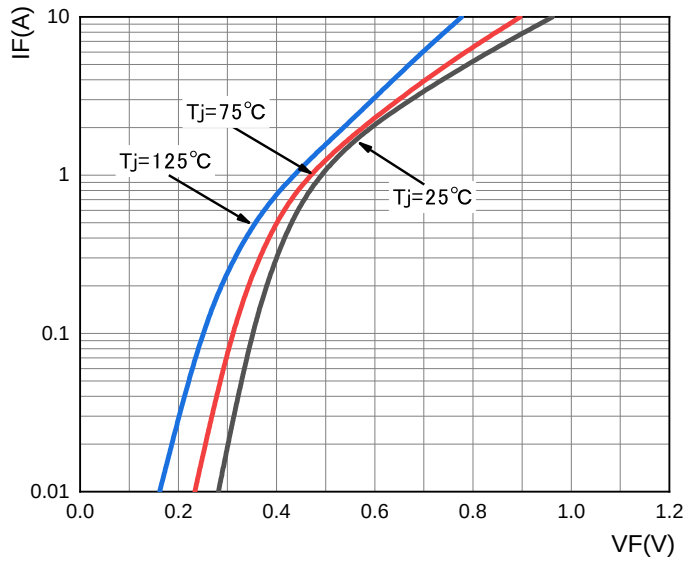
FIG.4: TYPICAL REVERSE CHARACTERISTICS



Typical Characteristics

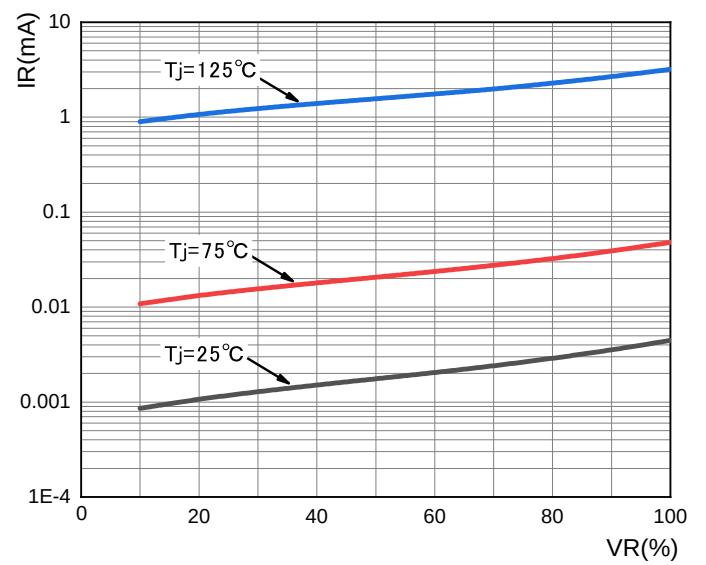
DSS25-DSS26

FIG.5: TYPICAL FORWARD CHARACTERISTICS



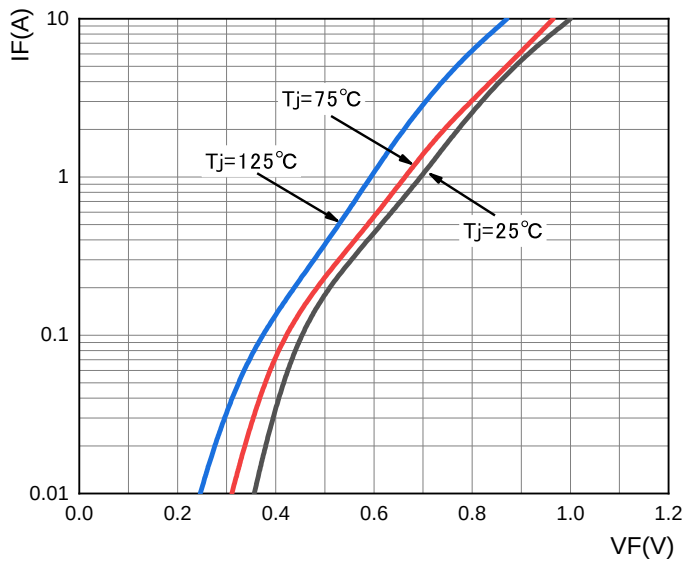
DSS25-DSS26

FIG.6: TYPICAL REVERSE CHARACTERISTICS



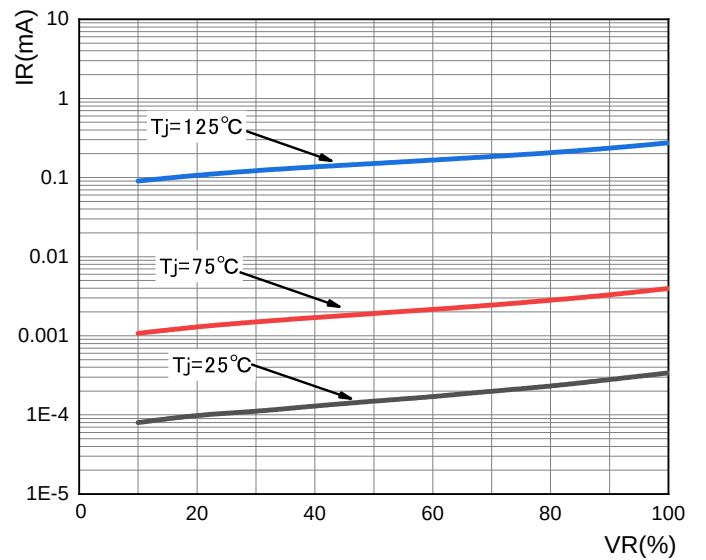
DSS28-DSS210

FIG.7: TYPICAL FORWARD CHARACTERISTICS



DSS28-DSS210

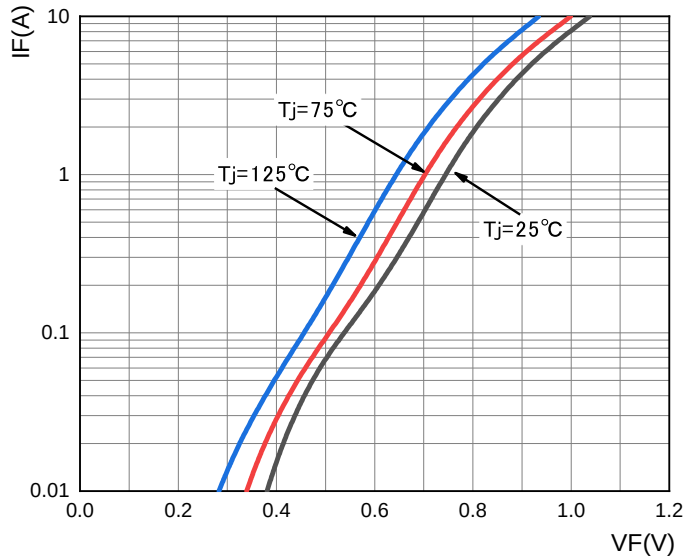
FIG.8: TYPICAL REVERSE CHARACTERISTICS



Typical Characteristics

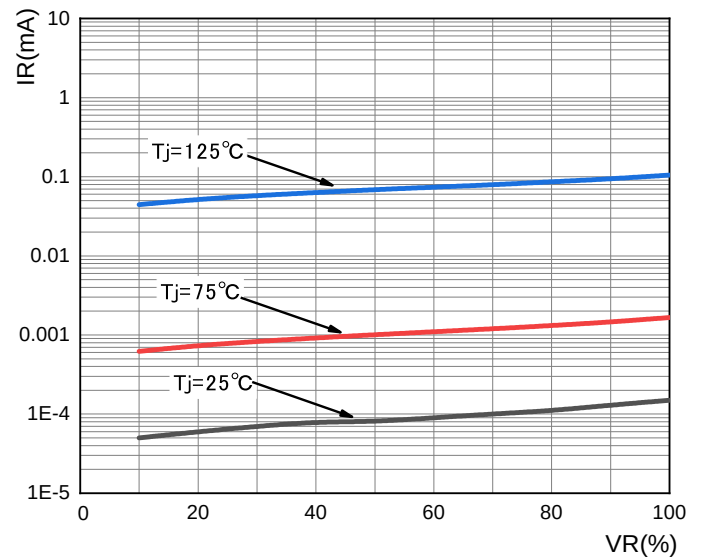
DSS215

FIG.9: TYPICAL FORWARD CHARACTERISTICS



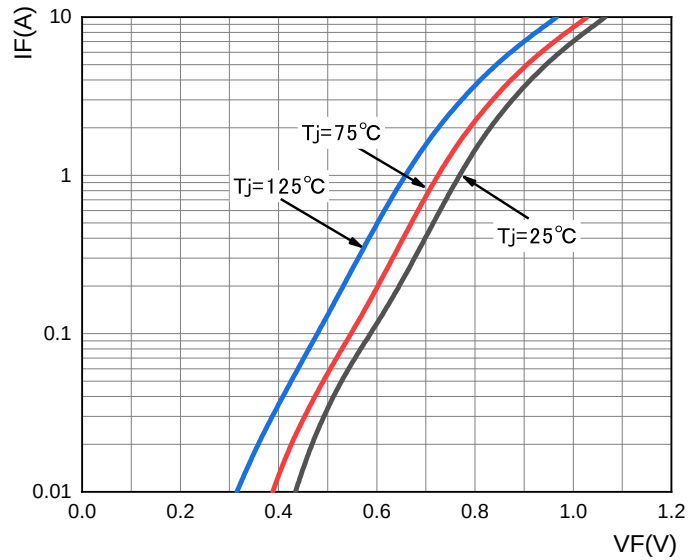
DSS215

FIG.10: TYPICAL REVERSE CHARACTERISTICS



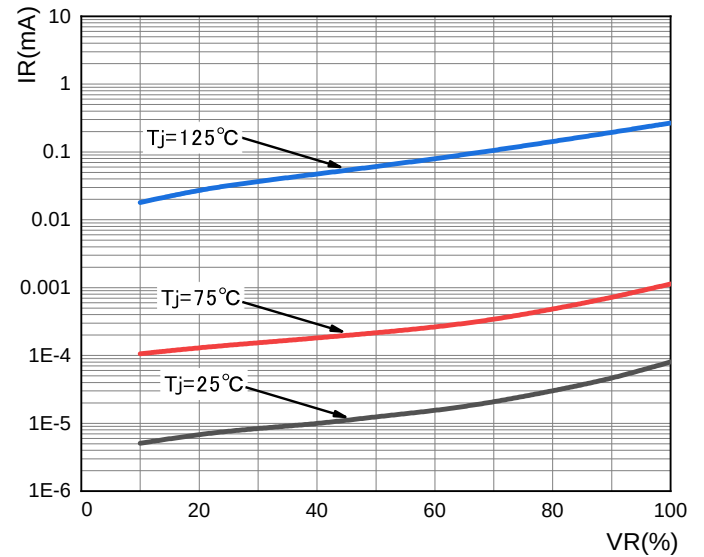
DSS220

FIG.11: TYPICAL FORWARD CHARACTERISTICS

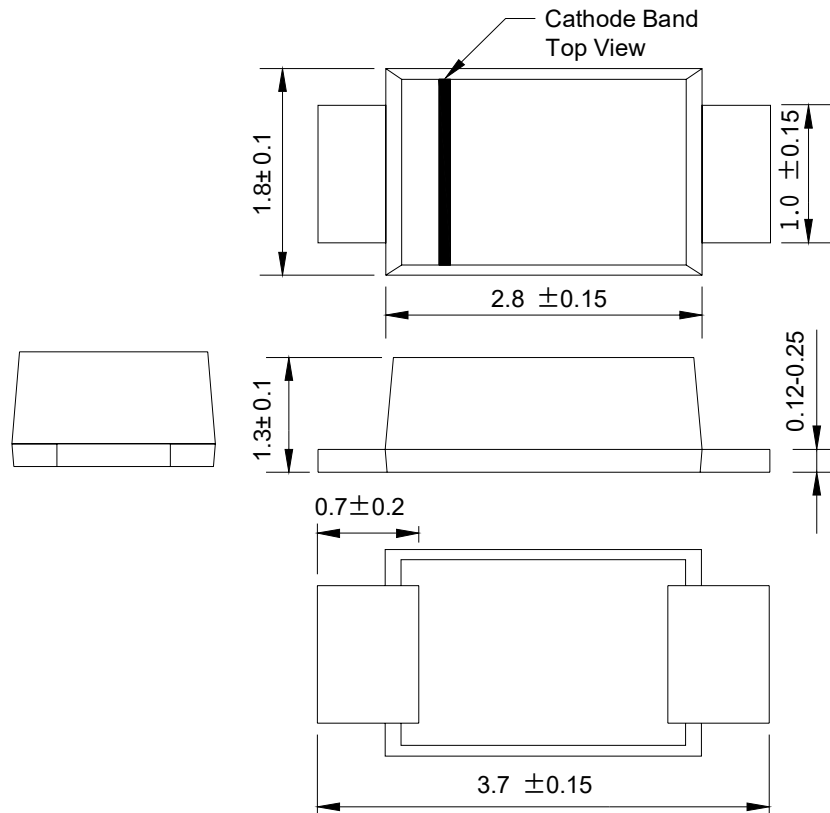


DSS220

FIG.12: TYPICAL REVERSE CHARACTERISTICS

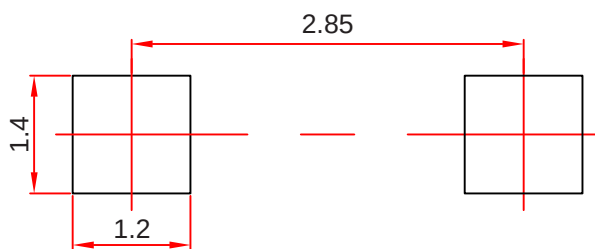


SOD-123FL Package Outline Dimensions



Dimensions in millimeters

SOD-123FL Suggested Pad Layout



Note:

1. Controlling dimension: in millimeters.
2. General tolerance: ± 0.05 mm.
3. The pad layout is for reference purposes only.

NOTICE

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Reel Taping Specifications For Surface Mount Devices–SOD-123FL

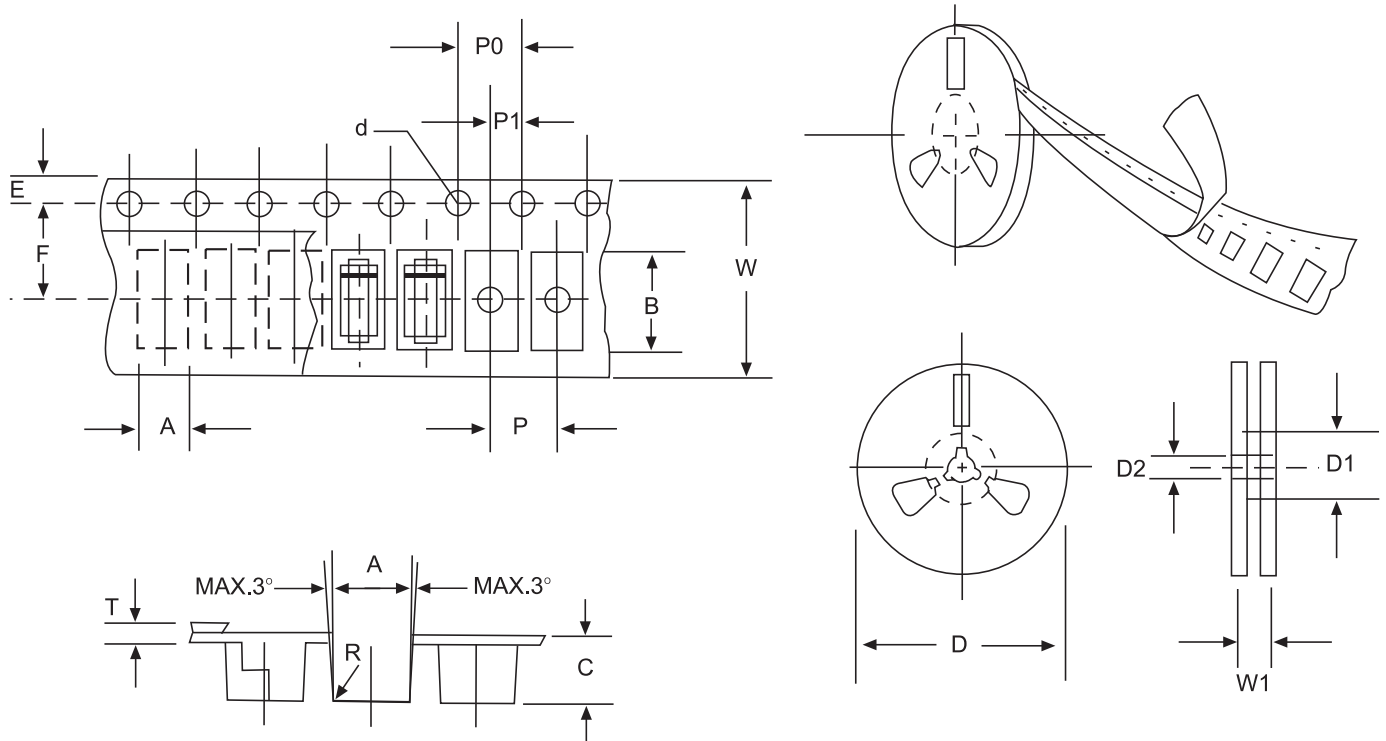


FIG:CONFIGURATION OF SURFACE MOUNTED DEVICES TAPING

ITEM	SYMBOL	SOD-123FLmm(inch)
Carrier width	A	2.05±0.1(0.081±0.004)
Carrier length	B	3.95±0.1(0.156±0.004)
Carrier depth	C	1.45±0.1(0.057±0.004)
Sprocket hole	d	1.55±0.05(0.061±0.002)
Reel outside diameter	D	178±2.0(7.0±0.079)
Reel inner diameter	D1	54±1.0(2.13±0.039)
Feed hole diameter	D2	13±0.5(0.512±0.020)
Strocket hole position	E	1.75±0.1(0.069±0.004)
Punch hole position	F	3.50±0.1(0.138±0.002)
Punch hole pitch	P	4.0±0.1(0.157±0.004)
Sprocket hole pitch	P0	4.0±0.1(0.157±0.004)
Embossment center	P1	2.0±0.1(0.079±0.004)
Totall tape thickness	T	0.21±0.25(0.008±0.010)
Tape width	W	8.0±0.2(0.315±0.008)
Reel width	W1	10.0±2.0(0.394±0.079)

NOTE:Devices are packed in accordance with EIA standard RS-481-A and specification given above.